Dual N-Channel 150-V (D-S) MOSFET

GENERAL DESCRIPTION

The ME4972-G is the N-Channel logic enhancement mode power field effect transistors, using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on state resistance. These devices are particularly suited for low voltage application such as cellular phone, notebook computer power management and other battery powered circuits, and low in-line power loss that are needed in a very small outline surface mount package.

FEATURES

- $R_{DS(ON)} \leqq 376m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} \leqq 360m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

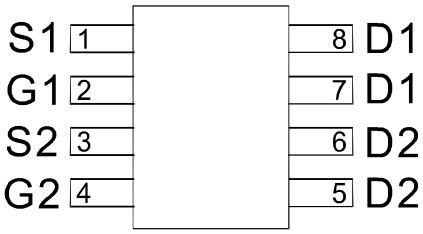
APPLICATIONS

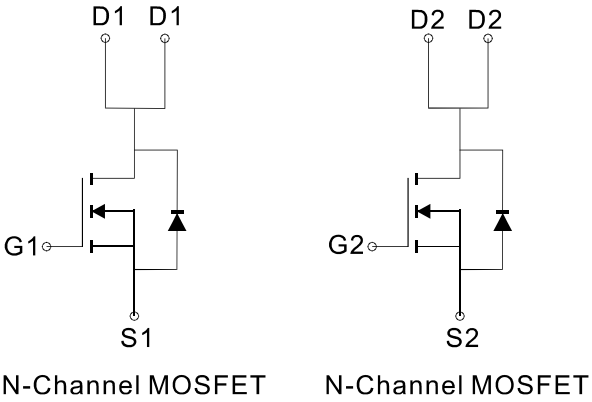
- Power Management in Note book
- DC/DC Converter
- Load Switch
- LCD Display inverter

PIN CONFIGURATION

(SOP-8)

Top View





Ordering Information: ME4972-G (Green product-Halogen free)

Absolute Maximum Ratings (T_A=25℃ Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_A=25℃	I_D	1.9	A
	T_A=70℃		1.5	
Pulsed Drain Current		I_{DM}	7	A
Maximum Power Dissipation	T_A=25℃	P_D	2	W
	T_A=70℃		1.3	
Operating Junction and Storage Temperature Range		TJ, Tstg	-55 to 150	℃
Thermal Resistance-Junction to Case *		$R_{\theta JA}$	62.5	℃/W

* The device mounted on 1in^2 FR4 board with 2 oz copper

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Electrical Characteristics (T_A=25℃ Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	150			V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250μA	1		3	V
I_{GSS}	Gate Leakage Current	V_{DS}=0V, V_{GS}=±20V			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=120V, V_{GS}=0V			1	μA
$R_{DS(ON)}$	Drain-Source On-Resistance [a]	V_{GS}=10V, I_D= 7A		313	376	mΩ
		V_{GS}=4.5V, I_D= 6A		300	360	
V_{SD}	Diode Forward Voltage	I_S=1.8A, V_{GS}=0V			1.3	V
DYNAMIC						
Qg	Total Gate Charge	V_{DS}=75V, V_{GS}=10V, I_D=7A		16.1		nC
Qgs	Gate-Source Charge			5.2		
Qgd	Gate-Drain Charge			4.2		
Ciss	Input Capacitance	V_{DS}=25V, V_{GS}=0V,f=1MHz		657		pF
Coss	Output Capacitance			34		
Crss	Reverse Transfer Capacitance			7		
td(on)	Turn-On Delay Time	V_{DS}=75V, R_L =10.68Ω, V_{GS}=10V, R_G=6Ω I_D=7A		9.8		ns
tr	Turn-On Rise Time			11.1		
td(off)	Turn-Off Delay Time			29.3		
tf	Turn-Off Fall Time			24.4		

Notes: a. Pulse test: pulse width≦ 300us, duty cycle≦ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

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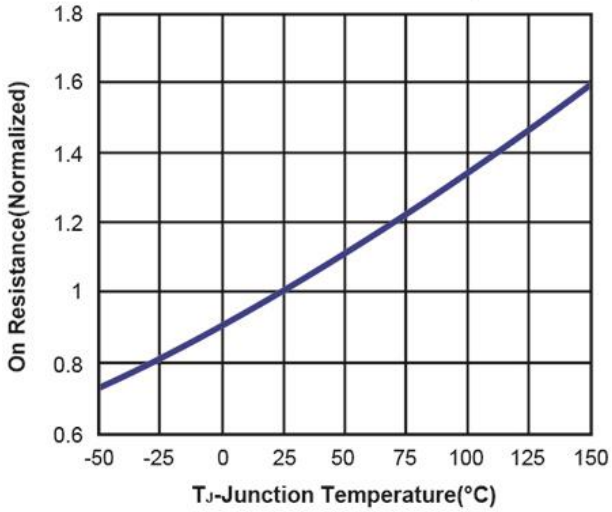
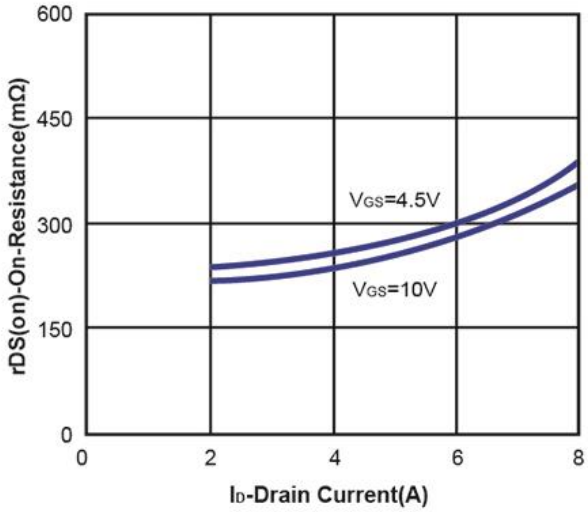
Typical Characteristics (T_J =25℃ Noted)

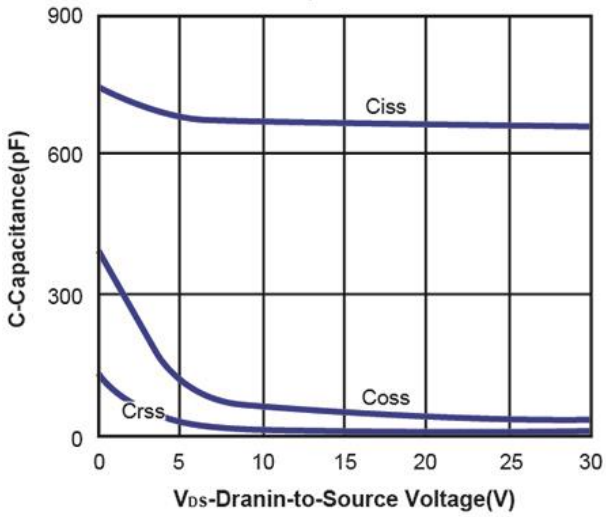
On Resistance vs. Junction Temperature



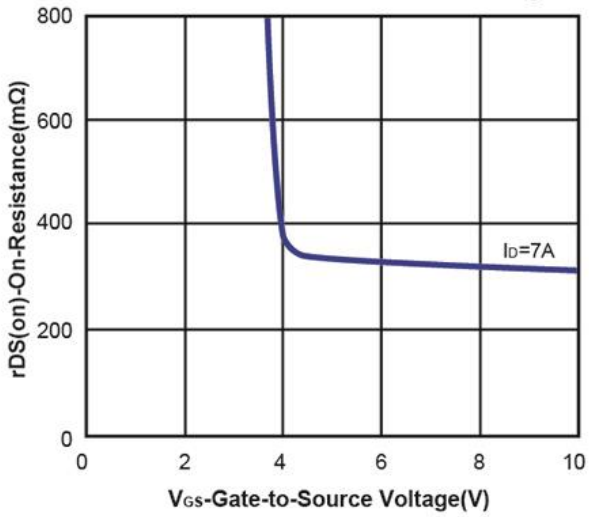
On Resistance vs. Drain Current



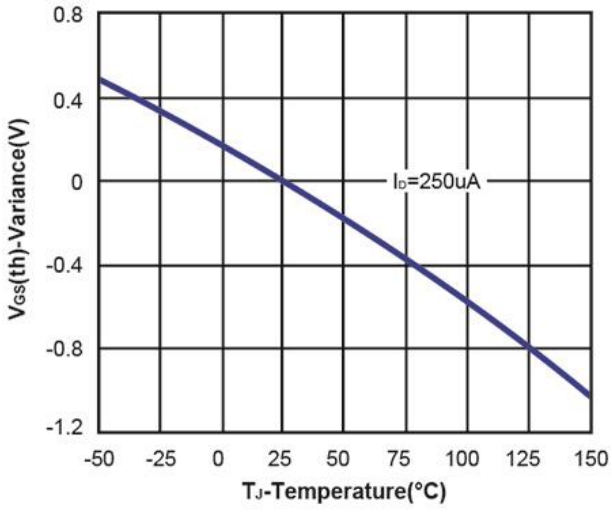
Capacitance



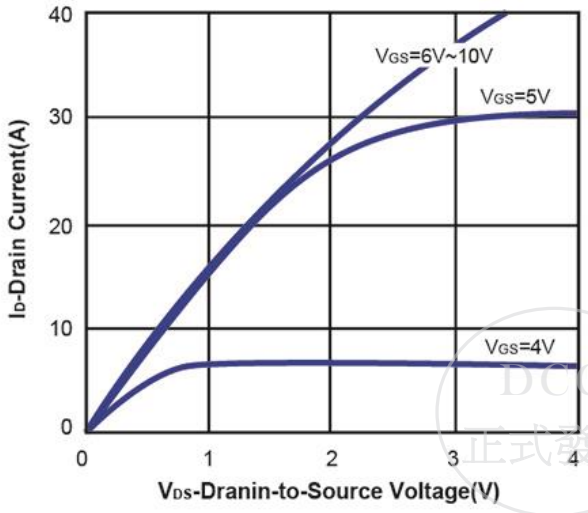
On Resistance vs. Gate-to-Source Voltage



Threshold Voltage



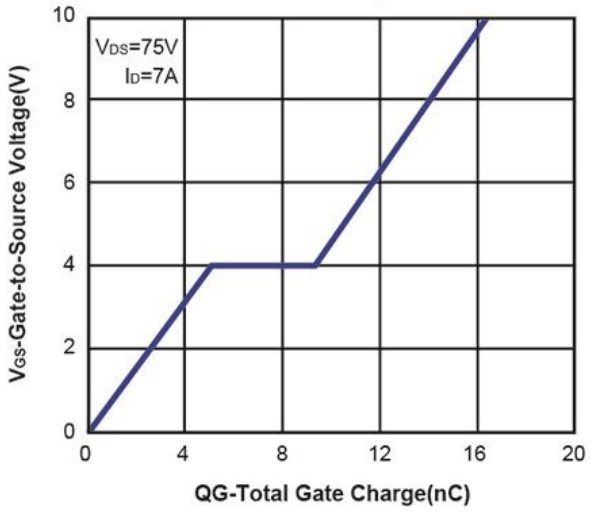
On-Region Characteristics



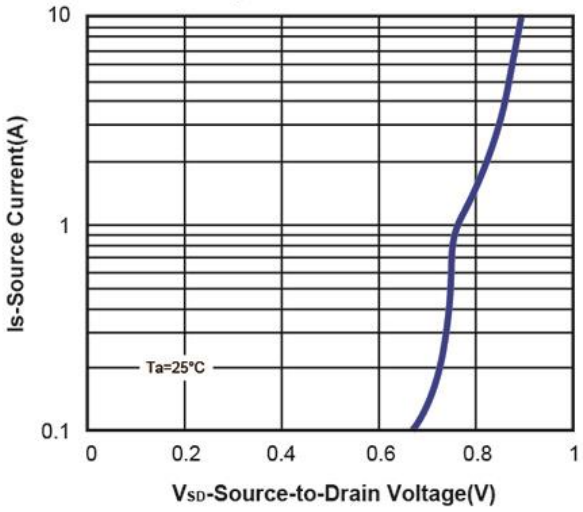
Dual N-Channel 150-V (D-S) MOSFET

Typical Characteristics (T_J =25℃ Noted)

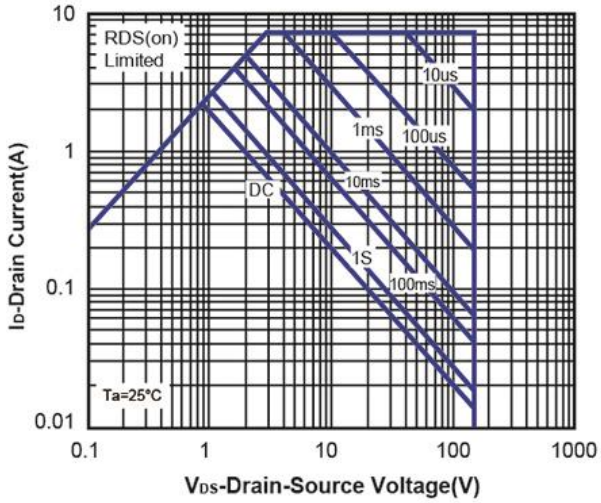
Gate Charge



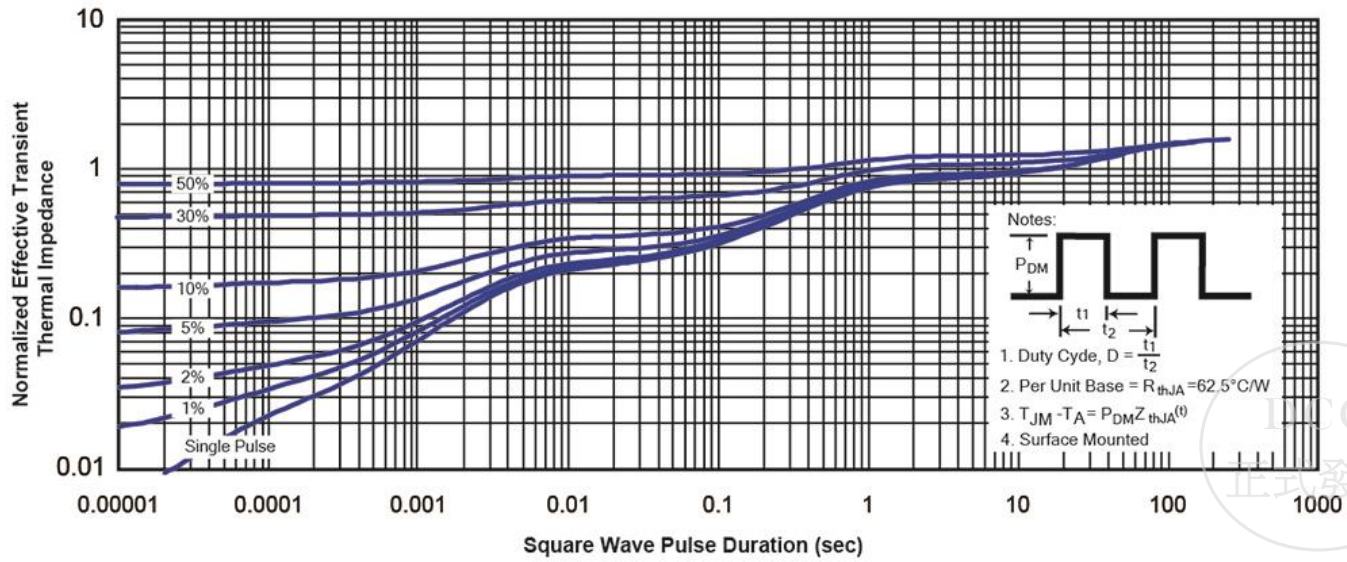
Body-diode characteristics



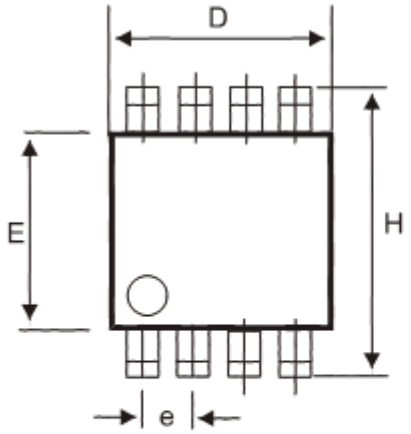
Maximum Forward Biased Safe Operating Area

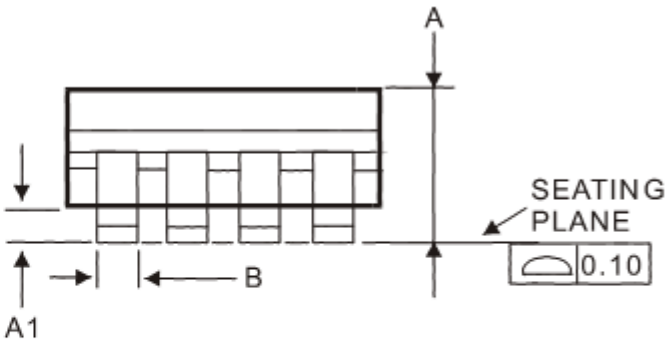


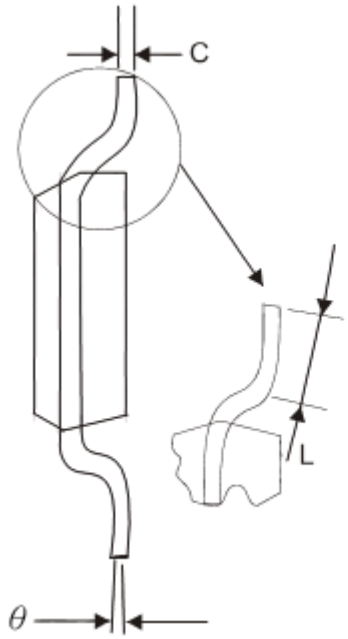
Normalized Thermal Transient Impedance, Junction-to-Ambient



SOP-8 Package Outline







DIM	MILLIMETERS (mm)	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.18	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
L	0.40	1.25
θ	0°	7°